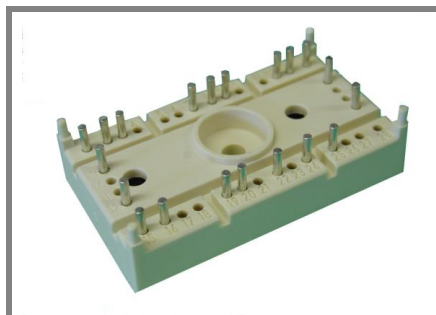




SEMITOP® 3

3-phase bridge rectifier + brake chopper

SK 55 DGL 126

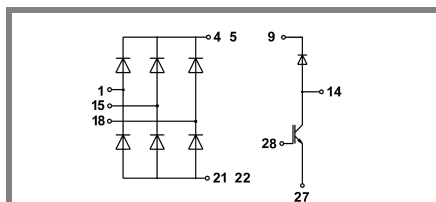
Target Data

Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminum oxide ceramic (DCB)
- Trench IGBT technology
- CAL Technology FWD

Typical Applications

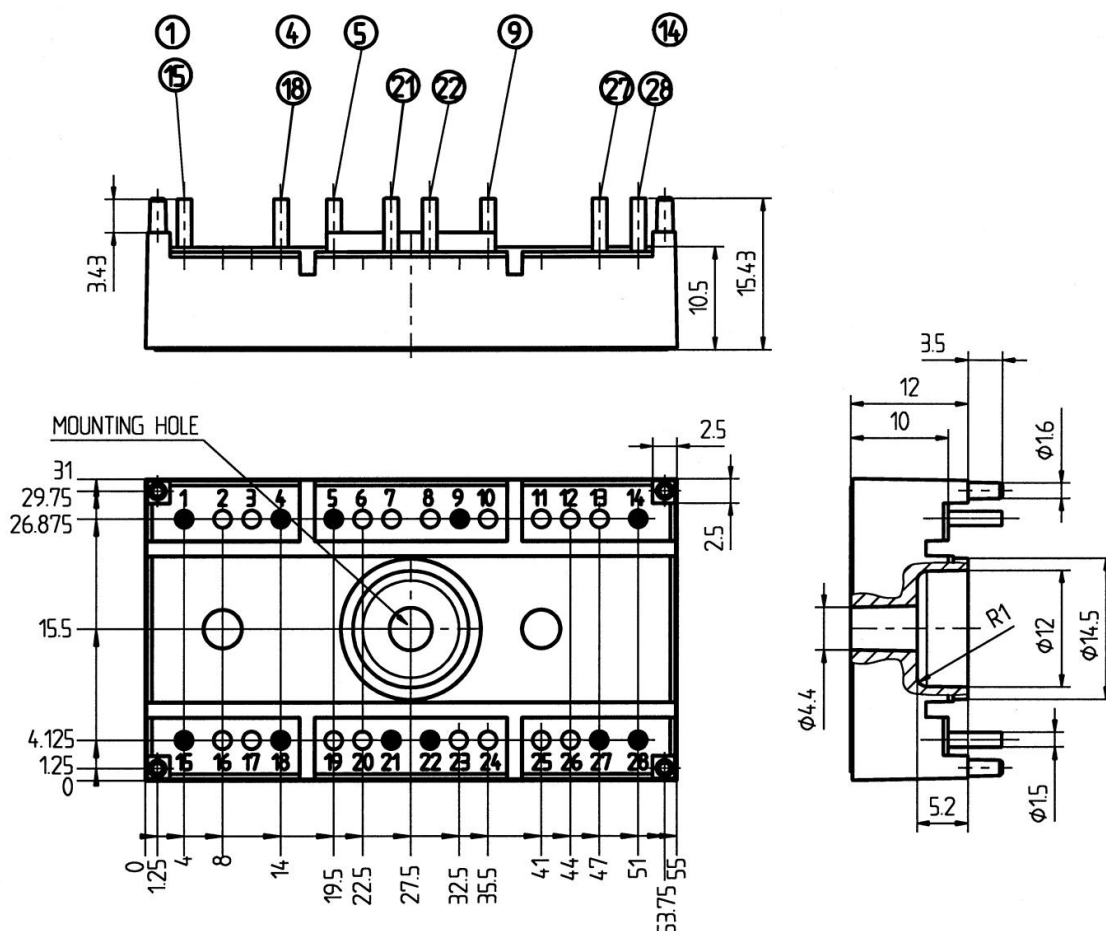
- Rectifier



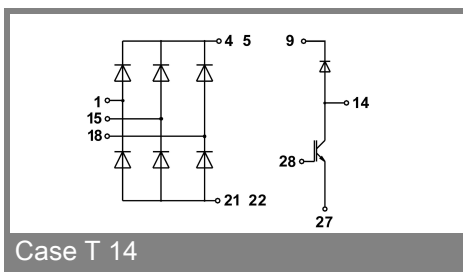
DGL

Absolute Maximum Ratings		$T_s = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT - Chopper			
V_{CES}		1200	V
I_C	$T_s = 25 (80)^\circ\text{C}$	40 (32)	A
I_{CM}	$T_s = 25 (80)^\circ\text{C}$, $t_p \leq 1 \text{ ms}$	80 (64)	A
V_{GES}		± 20	V
T_j		-40 ... +150	$^\circ\text{C}$
Diode - Chopper			
I_F	$T_s = 25 (80)^\circ\text{C}$	45 (35)	A
$I_{FM} = -I_{CM}$	$T_s = 25 (80)^\circ\text{C}$, $t_p \leq 1 \text{ ms}$	90 (70)	A
T_j		-40 ... +150	$^\circ\text{C}$
Rectifier			
V_{RRM}		1600	V
I_{FAV} / I_{TAV}	$T_s = 80^\circ\text{C}$	20	A
I_{FSM} / I_{TSM}	$t_p = 10 \text{ ms}$, $\sin 180^\circ$, $T_j = 25^\circ\text{C}$	370	A
I_t^2	$t_p = 10 \text{ ms}$, $\sin 180^\circ$, $T_j = 25^\circ\text{C}$	685	A^2s
T_j		-40 ... +150	$^\circ\text{C}$
T_{sol}	Terminals, 10s	260	$^\circ\text{C}$
T_{stg}		-40 ... +125	$^\circ\text{C}$
V_{isol}	AC, 1 min. / 1s	2500 / 3000	V

Characteristics		$T_s = 25^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT - Chopper					
V_{CEsat}	$I_C = 35 \text{ A}$, $T_j = 25 (125)^\circ\text{C}$		1,7 (2)	2,1	V
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 1,5 \text{ mA}$	5	5,8	6,5	V
$V_{CE(TO)}$	$T_j = 25^\circ\text{C}$ (125) $^\circ\text{C}$		1 (0,9)	1,2	V
r_T	$T_j = 25^\circ\text{C}$ (125) $^\circ\text{C}$		20 (31)	26	$\text{m}\Omega$
C_{ies}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1 \text{ MHz}$		2,4		nF
C_{oes}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1 \text{ MHz}$		0,5		nF
C_{res}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1 \text{ MHz}$		0,4		nF
$R_{th(j-s)}$	per IGBT			1,05	K/W
$t_{d(on)}$	under following conditions		85		ns
t_r	$V_{CC} = 300 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$		30		ns
$t_{d(off)}$	$I_C = 30 \text{ A}$, $T_j = 125^\circ\text{C}$		430		ns
t_f	$R_{Gon} = R_{Goff} = 22 \Omega$		90		ns
E_{on}	inductive load		4,6		mJ
E_{off}			4,3		mJ
Diode - Chopper					
$V_F = V_{EC}$	$I_F = 45 \text{ A}$, $T_j = 25 (125)^\circ\text{C}$		1,5 (1,5)	1,77 (1,77)	V
$V_{(TO)}$	$T_j = 125^\circ\text{C}$		(0,92)		V
r_T	$T_j = 125^\circ\text{C}$		(13,4)		$\text{m}\Omega$
$R_{th(j-s)}$	per diode			1,2	K/W
I_{RRM}	under following conditions		30		A
Q_{rr}	$I_F = 50 \text{ A}$, $V_R = 600 \text{ V}$		10		μC
E_{rr}	$V_{GE} = 0 \text{ V}$, $T_j = 125^\circ\text{C}$				mJ
	$di_F/dt = 500 \text{ A}/\mu\text{s}$				
Diode rectifier					
V_F	$I_F = 25 \text{ A}$, $T_j = 25^\circ\text{C}$			1,25	V
$V_{(TO)}$	$T_j = 150^\circ\text{C}$		0,8		V
r_T	$T_j = 150^\circ\text{C}$		13		$\text{m}\Omega$
$R_{th(j-s)}$	per diode		2		K/W
Temperatur sensor					
R_{ts}	%, $T_r = ()^\circ\text{C}$		()		Ω
Mechanical data					
w			30		g
M_s	Mounting torque			2,5	Nm



Case T 14 (Suggested hole diameter, in the PCB, for solder pins and plastic mounting pins: 2mm)



Case T 14

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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